

Today we would like to present 2 innovative series as follows:

# JST

Qualität die verbindet

## SERIES PLI

Crimp Wire-to-Board / THT  
Pitch 2.0 mm

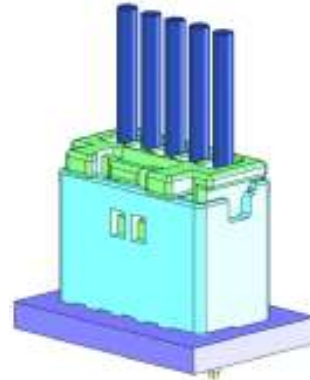
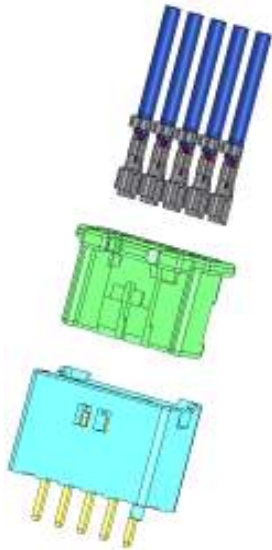
The inertia lock mechanism prevents an incomplete mating. The low profile in mating height (9.6 mm) allows the usage of this connector also in limited space.

Shrouded headers in DIP-version 2- to 10- pol., top entry available.

Depended on crimp contact this series can be used for wires from AWG 28 to AWG 22.

Current rating by using AWG 22: 3A, AC, DC  
Current rating by using AWG 24: 2A, AC, DC

voltage: 100 V AC, DC



## SERIES JADN

Board - to - Board / SMT  
Pitch 0.4 mm

BtB connector available in 2 different stacking heights: 0.8 mm and 1.0 mm

Stacking height 0.8 mm: at the moment available in 50-pol. / 36- and 44-pol. are under development.

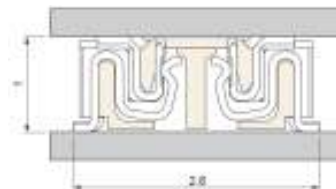
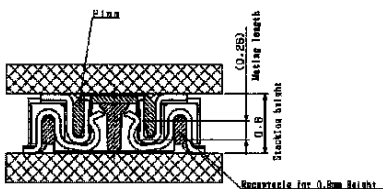
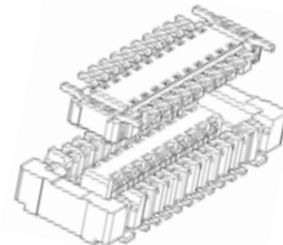
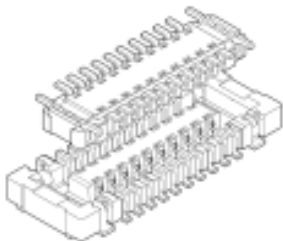
Stacking height 1.0 mm: at the moment available in 36- and 68-pol. / 44-pol. is under development.

By using the structure of contact lock you may feel the click when connectors are mated.

The plug connector can be used for both 0.8 mm and 1.0 mm stacking height connector.

Current rating:  
Stacking height 0.8 mm: 0.25 A AC, DC  
Stacking height 1.0 mm: 0.3 A AC, DC

voltage: 30V AC, DC



Please feel free to contact us:

Maybe you need samples or a quote? Please get in touch with us.